

Test Report PMP31404 3V to 42V Synchronous GaN Boost Converter Reference Design



Description

The reference design is designed for high boost factor and high efficiency. The design operates over a wide input voltage range, starting from 3V using the LMG5126 boost converter with integrated Gallium Nitride (GaN) field-effect transistors (FETs). The reference design includes features such as spread spectrum, current limit, thermal shutdown, overvoltage protection, and undervoltage lockout.

Resources

[PMP31404](#)

Design Folder

[LMG5126](#)

Product Folder

[LM2665](#)

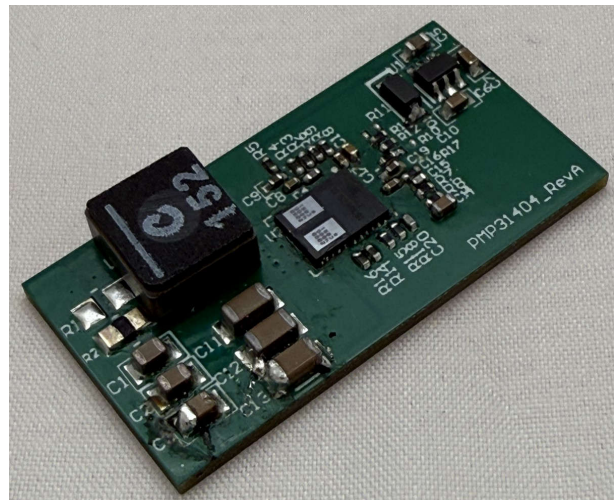
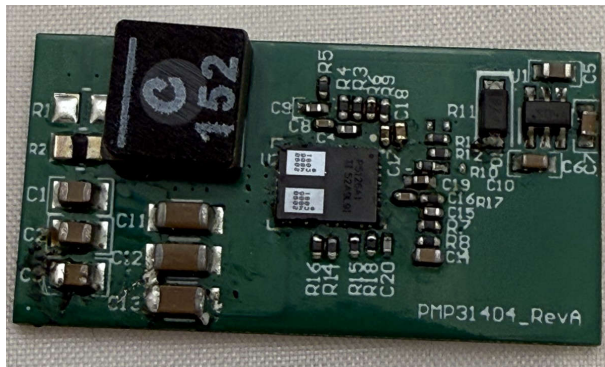
Product Folder

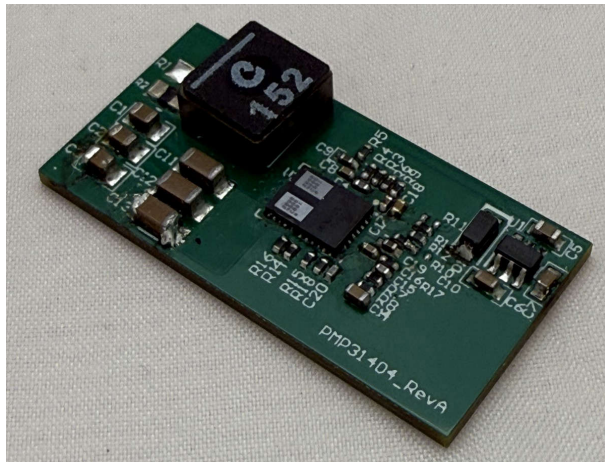
Features

- Small form factor reference design
- Ultra-high boost factor
- Low input voltage of 3V
- Synchronous GaN boost converter
- Inductor current monitoring and average current limit
- Programmable line undervoltage lockout (UVLO) and hysteresis

Applications

- [Portable Electronics](#)





1 Test Prerequisites

1.1 Voltage and Current Requirements

Table 1-1. Voltage and Current Requirements

Parameter	Specifications
Input Voltage Range	3V to 6V
Output Voltage	42V
Maximum Output Current	0.45A
Topology	Boost
Actual Switching Frequency	588kHz

1.2 Considerations

Unless otherwise indicated the input voltage was set to 3V and the output current was adjusted to 0.45A with an electronic load.

1.3 Dimensions

The outline of the board is 35mm × 18mm. The copper thickness of the outer layers are 70μm and for the inner layer 105μm.

2 Testing and Results

2.1 Efficiency Graphs

Bias supply was disconnected.

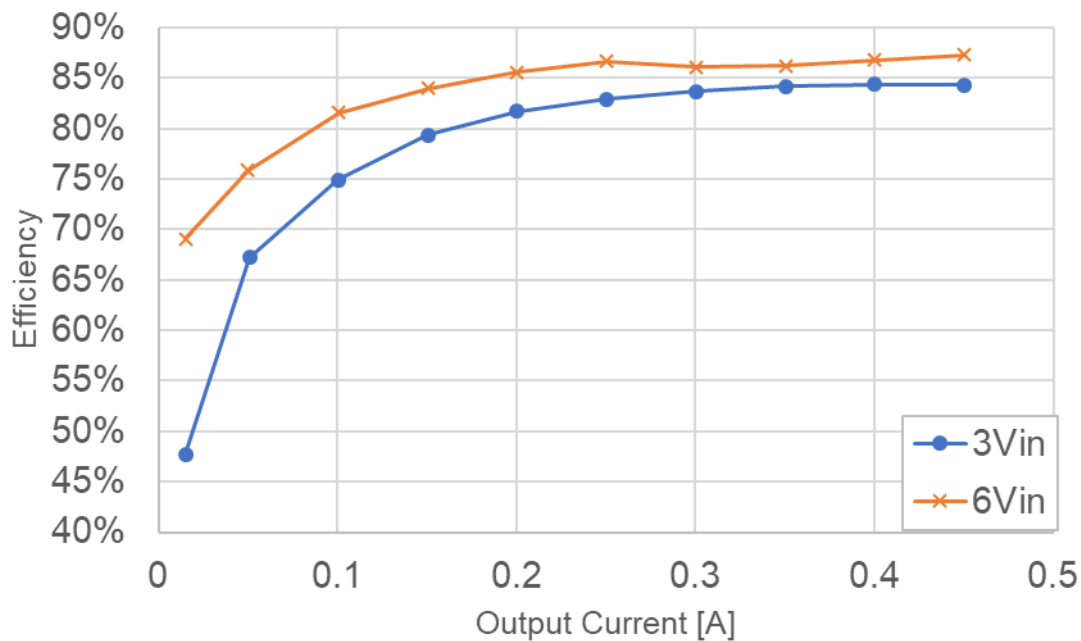


Figure 2-1. Efficiency Graph

2.2 Loss Graph

Bias supply was disconnected.

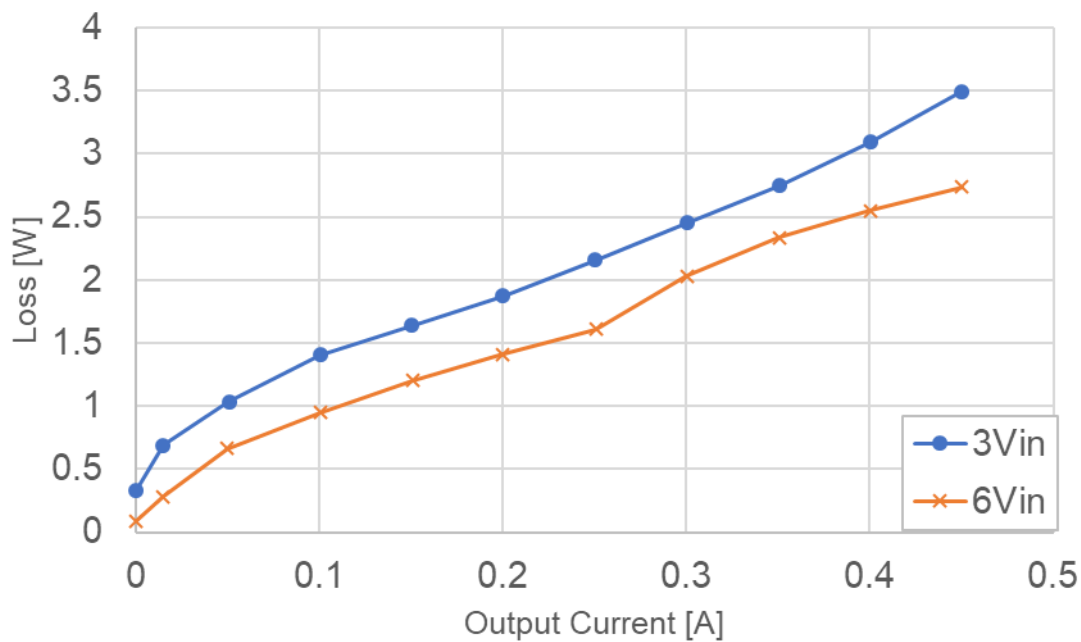


Figure 2-2. Loss Graph

2.3 Load Regulation

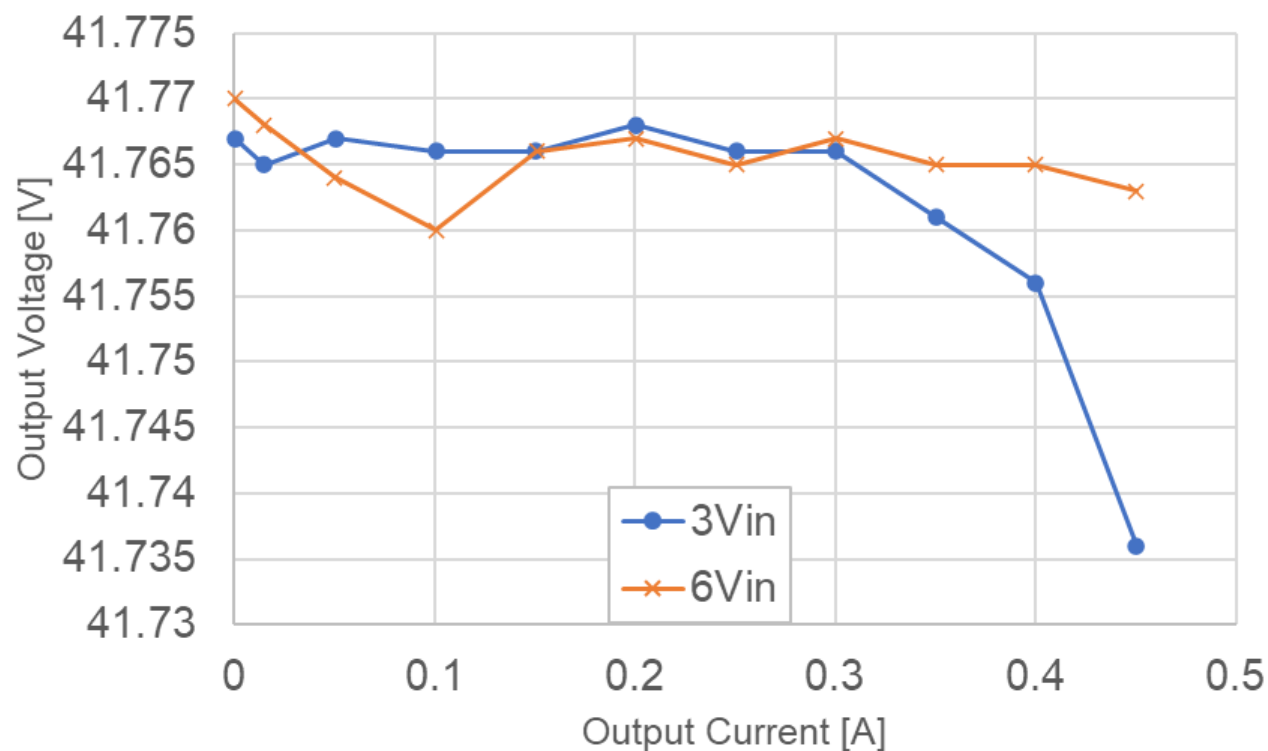


Figure 2-3. Load Regulation Graph

2.4 Thermal Image

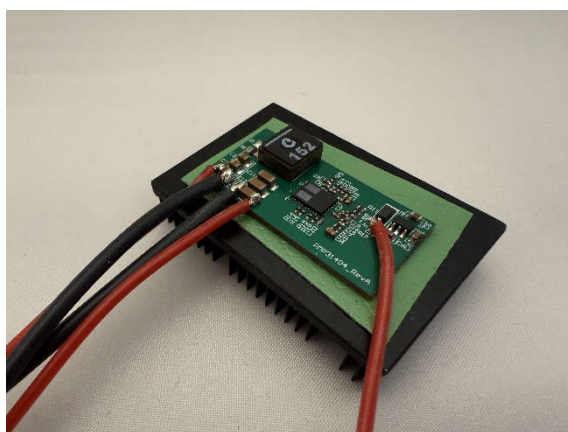


Figure 2-4. Heat Sink Connected to the Bottom of the Board

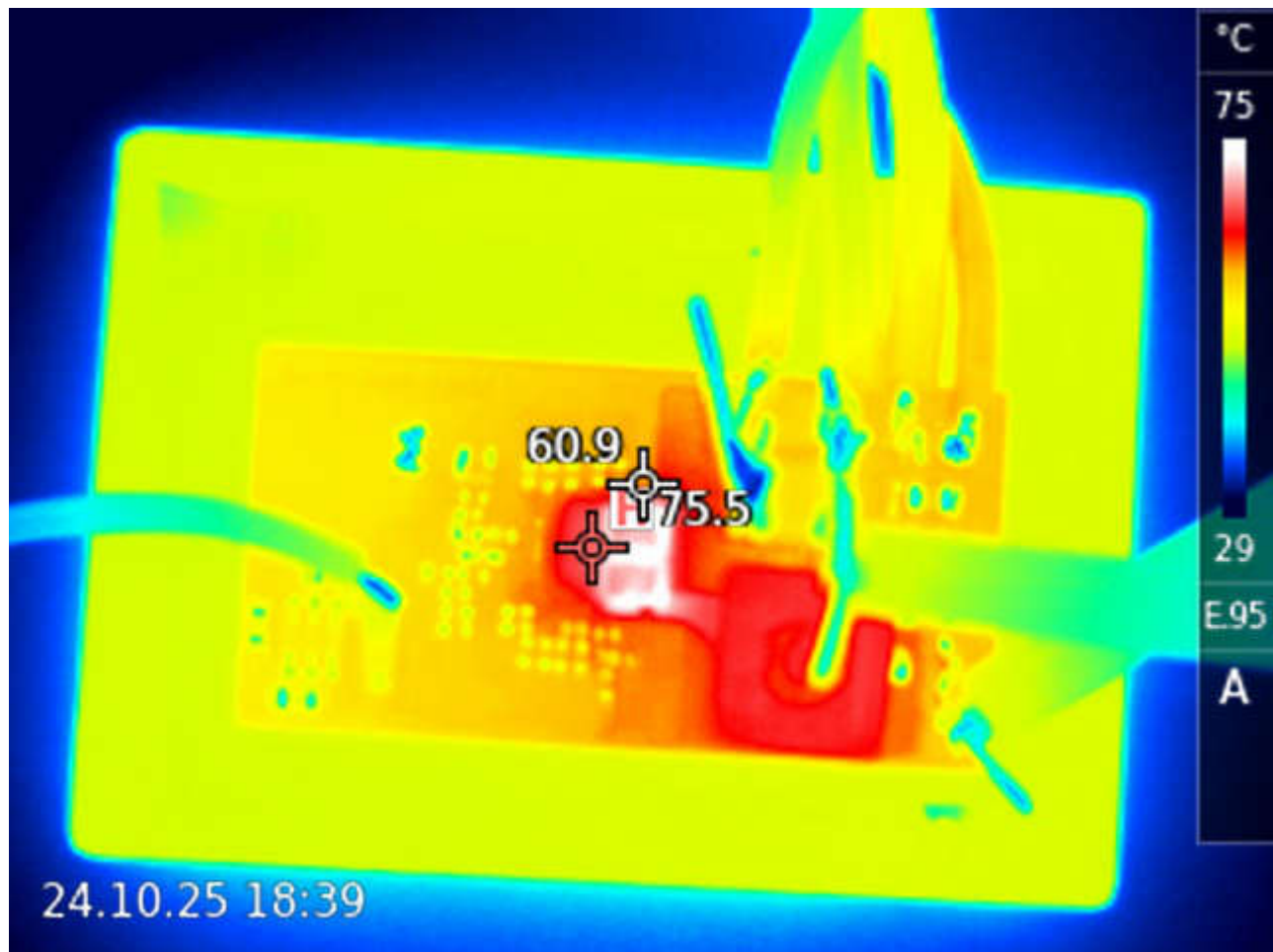


Figure 2-5. Thermal Image at $3V_{IN}$ and $0.45A_{OUT}$

3 Waveforms

3.1 Switching

3.1.1 3V Input Voltage

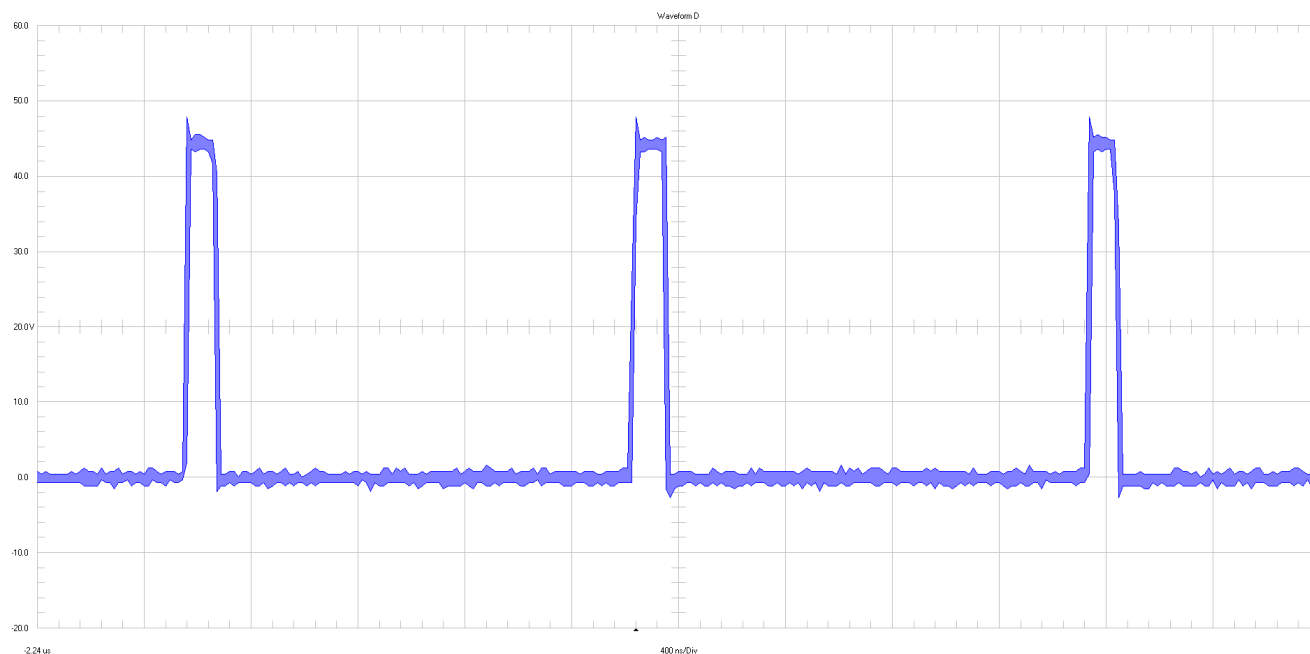


Figure 3-1. Switching With 3V Input Voltage (10V/div, 400ns/div, Full Bandwidth)

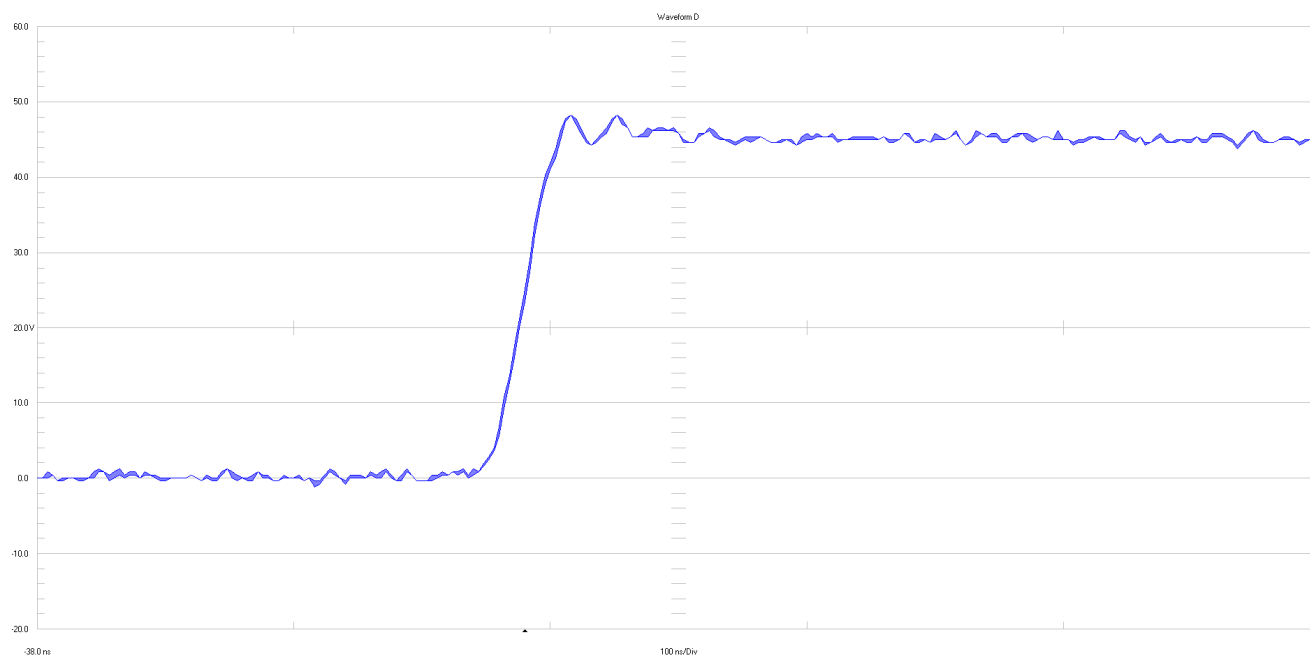


Figure 3-2. Switching With 3V Input Voltage Low High Transition (10V / div, 100ns Full Scale, Full Bandwidth)

3.1.2 6V Input Voltage

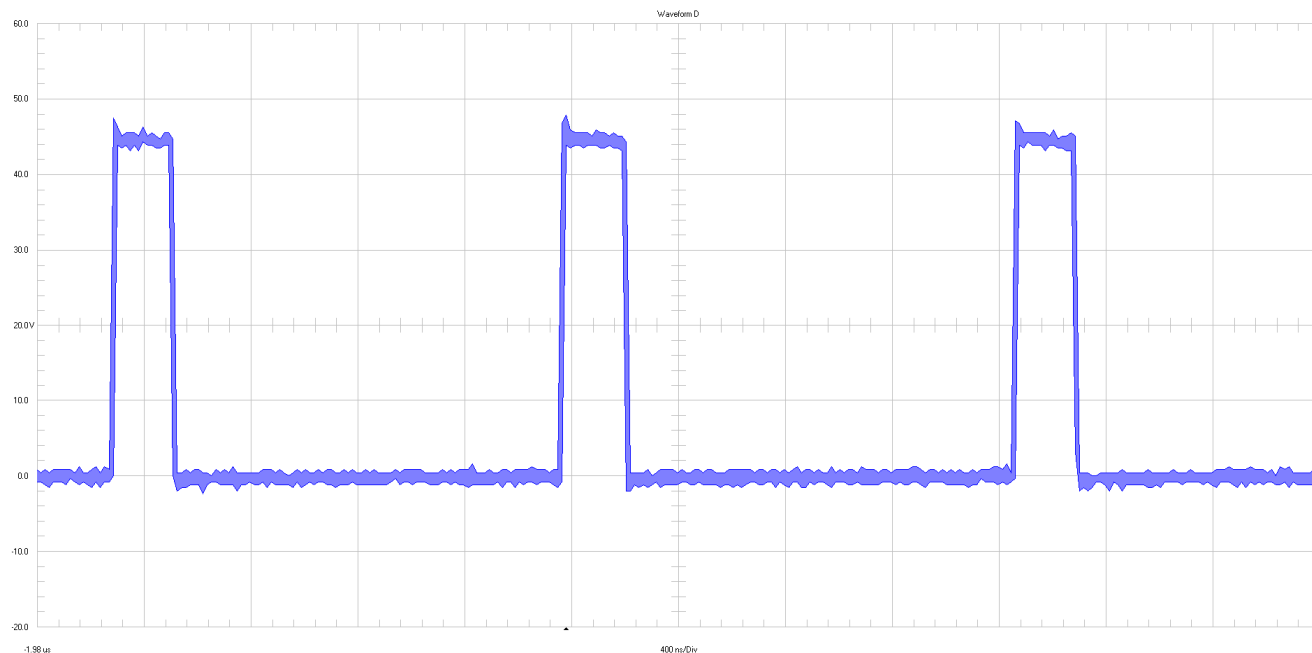


Figure 3-3. Switching With 6V_{IN} (10V/div, 400ns/div, Full Bandwidth)

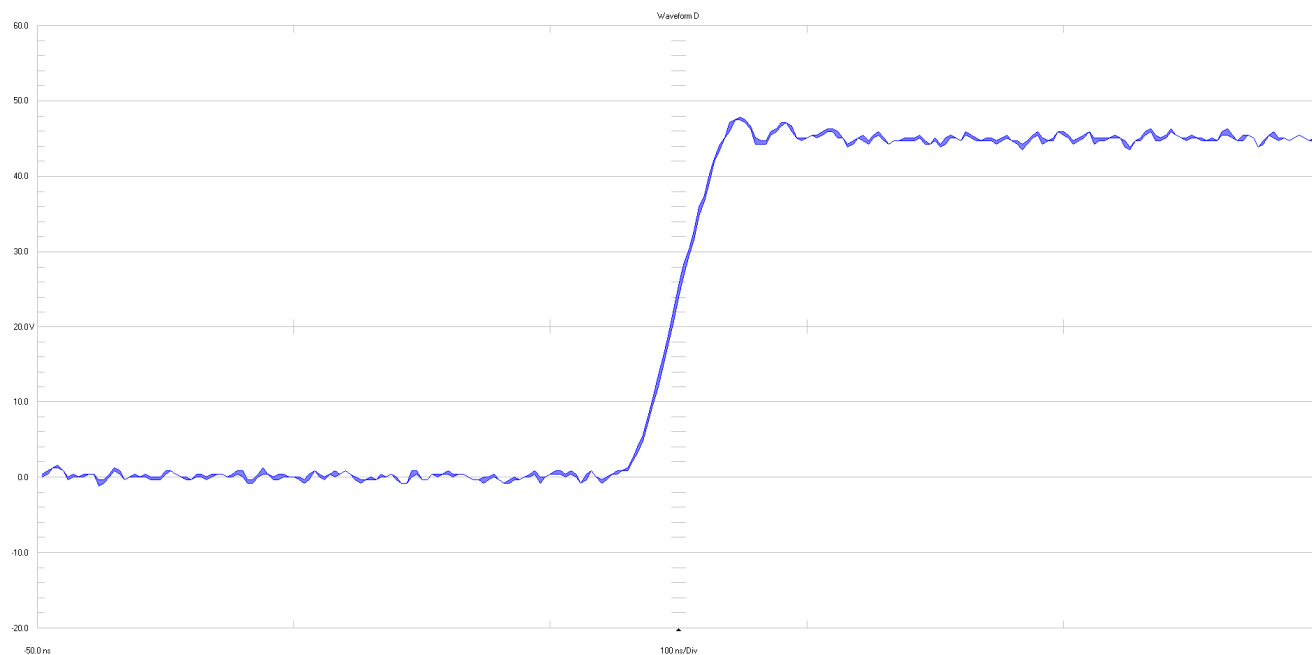


Figure 3-4. Switching With 6V_{IN} Voltage Low High Transition (10V / div, 100ns Full Scale, Full Bandwidth)

3.2 Output Voltage Ripple

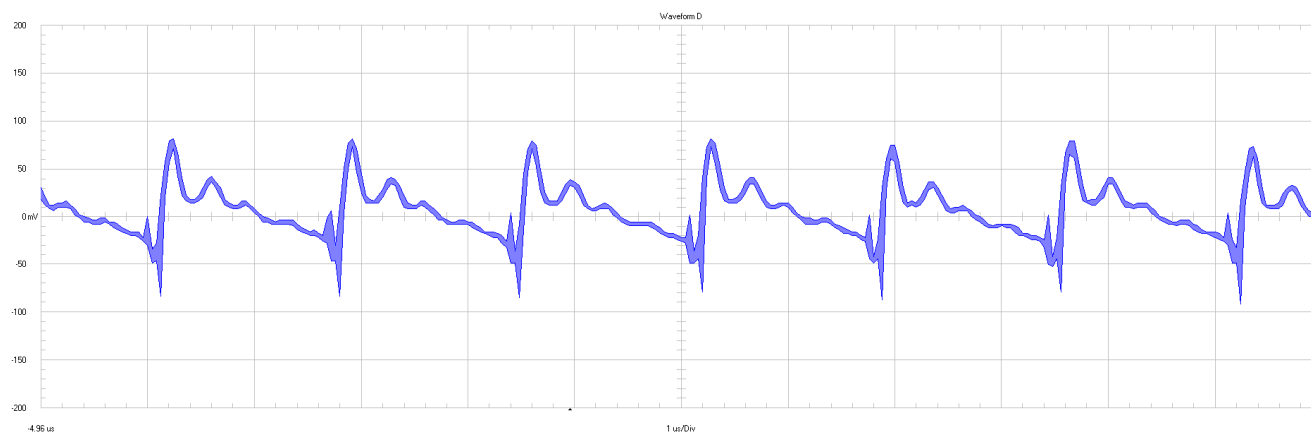


Figure 3-5. Output Voltage Ripple With 3V_{IN} (50mV/div, 1μs/div, 20MHz Bandwidth)

3.2.1 Input Voltage Ripple

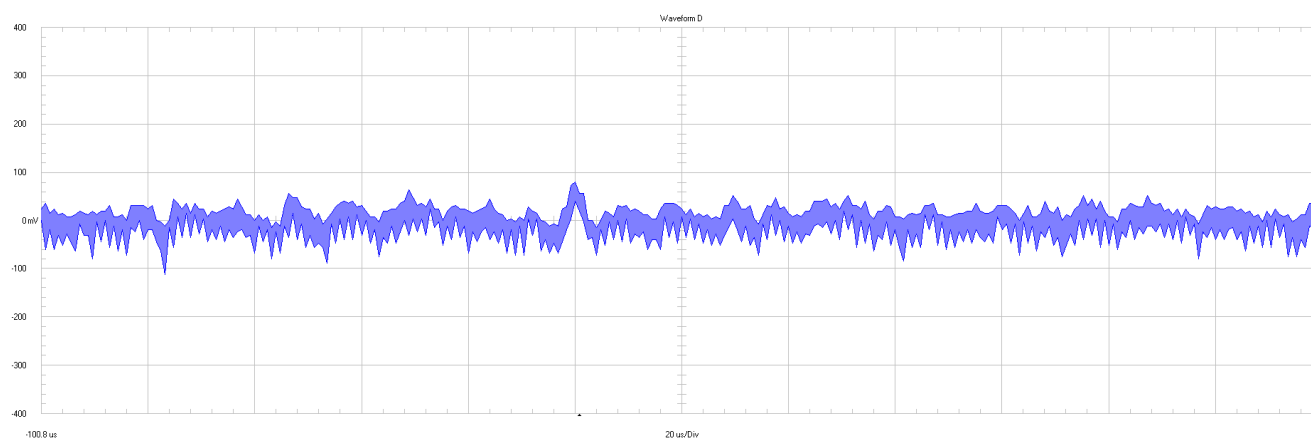


Figure 3-6. Input Voltage Ripple 3V_{IN} (100mV/div, 20μs/div, 20MHz Bandwidth)

3.3 Load Transients

3.3.1 3V Input Voltage

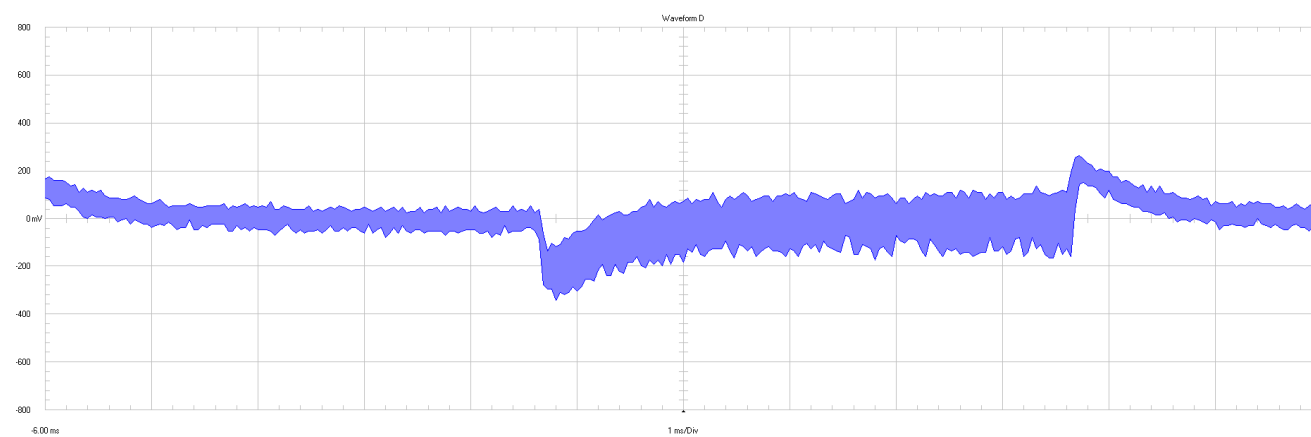


Figure 3-7. Load Transient 0.1A to 0.45A (V_{OUT}, 200mV / div, 1ms / div, 20MHz Bandwidth)

3.3.2 6V Input Voltage

3.3.2.1 0.1A to 0.45A

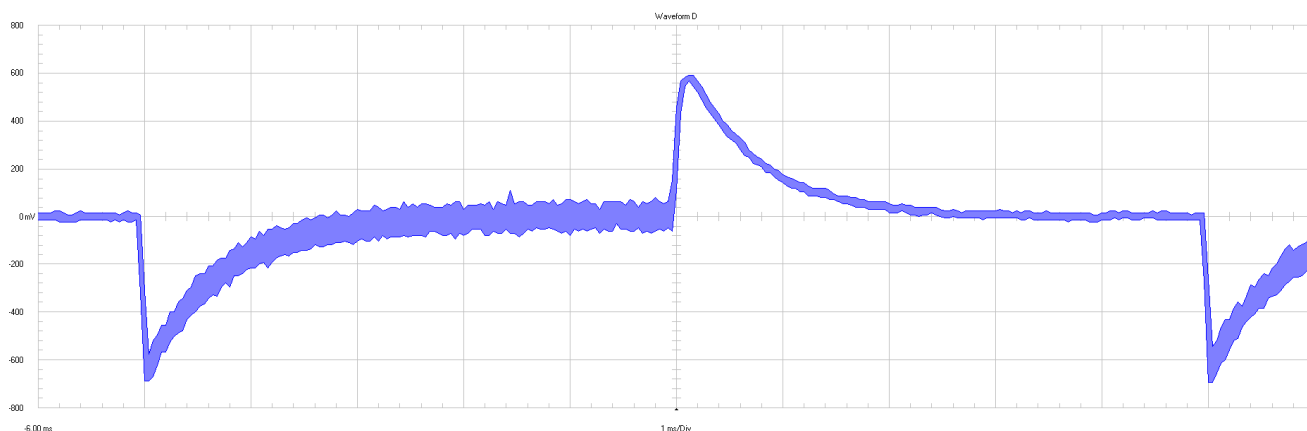


Figure 3-8. Load Transient 0.1A to 0.45A (V_{OUT} , 200mV / div, 1ms / div, 20MHz Bandwidth)

3.4 Start-up Sequence

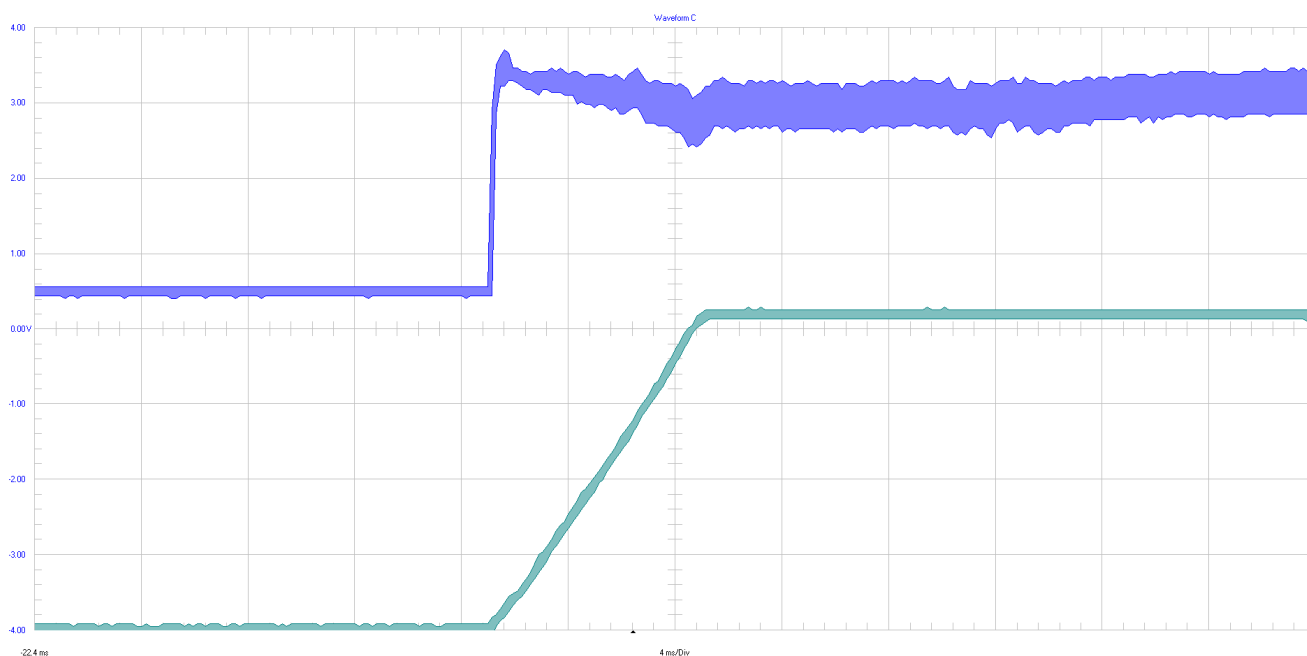


Figure 3-9. Start-Up With 3V_{IN} (Bias Supply Was Connected)

- Input voltage (1V / div, 2ms / div, 20MHz bandwidth)
- Output voltage (10V / div, 2ms / div, 20MHz bandwidth)

3.5 Shutdown Sequence

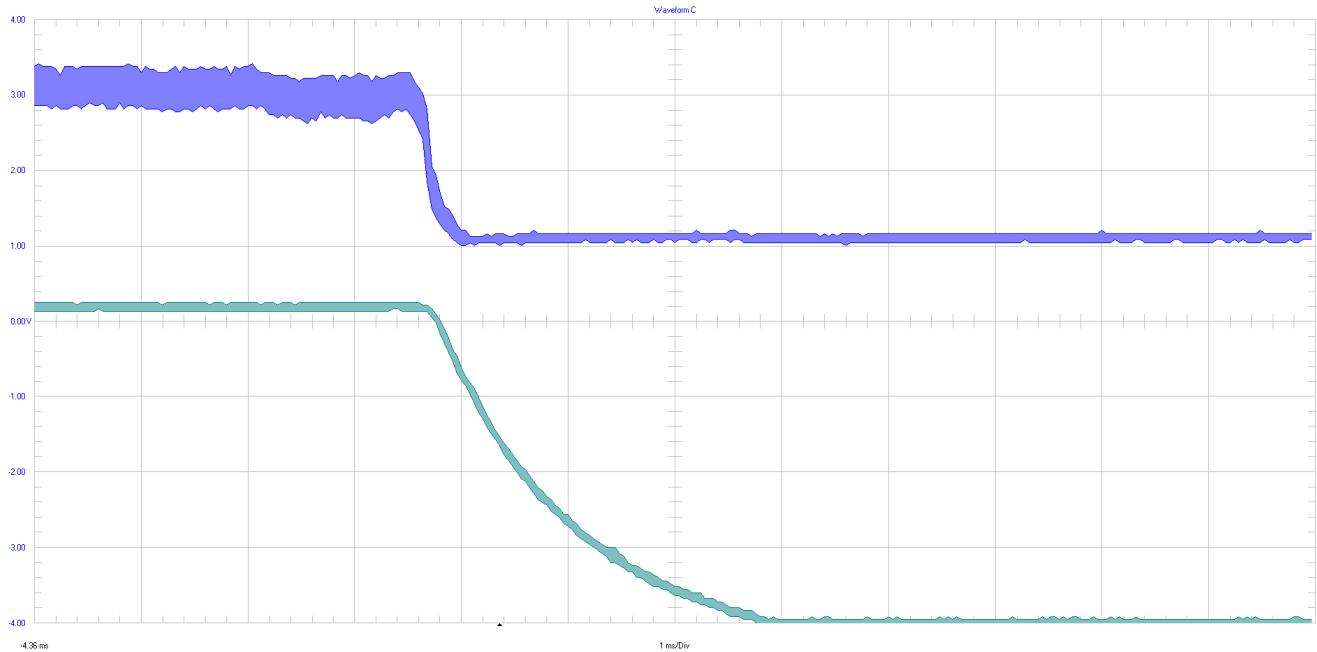


Figure 3-10. Shutdown With 3V_{IN} (Bias Supply Was Connected)

- Input voltage (1V / div, 1ms / div, 20MHz bandwidth)
- Output voltage (10V / div, 1ms / div, 20MHz bandwidth)

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Last updated 10/2025